

AMENDMENTS TO THE CLAIMS:

This listing of claims will replace all prior versions, and listings, of claims in the application:

LISTING OF CLAIMS:

1. (Currently Amended) A thermal trip device in which a bimetal is heated by overcurrent and performs trip operation of a circuit by curvature of said heated bimetal, wherein ~~at least one~~ a temperature measurement part of said bimetal is provided with a bending part bent substantially perpendicular to a longitudinal direction of said bimetal, and the surface of said bimetal bending part is made to be black.
2. (Canceled)
3. (Canceled)
4. (Currently Amended) The thermal trip device according to claim ~~[[3]]~~ 1, wherein the surface of said ~~temperature measurement~~ bending part of said bimetal is made to be matte black.
5. (Canceled)
6. (Canceled)

7. (Currently Amended) A thermal trip device in which a bimetal is heated by overcurrent and performs trip operation of a circuit by curvature of said heated bimetal, wherein a temperature measurement part of said bimetal is provided with a bending part bent substantially perpendicular to a longitudinal direction of said bimetal.

8. (Currently Amended) A circuit breaker having a thermal trip device in which a bimetal is heated by overcurrent and performs trip operation of a circuit by curvature of said heated bimetal, wherein ~~the surface of~~ a temperature measurement part of said bimetal is provided with a bending part bent substantially perpendicular to a longitudinal direction of said bimetal, and the surface of said bending part is made to be black.